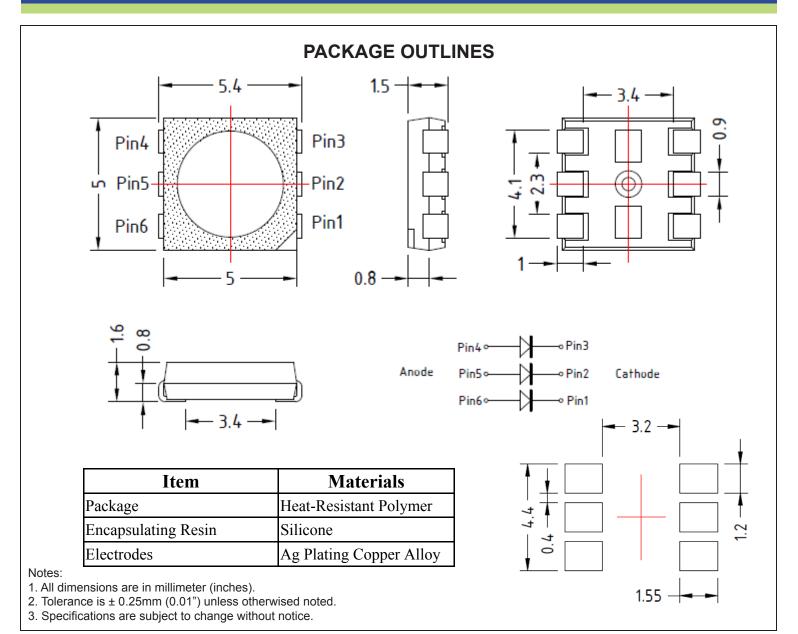


SPECIFICATIONS CSH22W4C



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSH22W4C	InGaN	White	Water Clear	120°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	70	mA	
Power Dissipation	Pd	250	mW	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	100	mA	
Reverse Voltage	VR	5	V	
Operating Temperature Range	Тор	-30~+100	°C	
Storage Temperature Range	Тѕтс	-40~+100	°C	
Soldering Temperature	Tsol	Max 260°C for 5 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Symbol	Toot Condition	Value			Lloit
Parameter		Test Condition	Min	Тур	Max	Unit
Reverse Current	lr	IF = 60mA	-	-	50	μΑ
CIE Coordinates	Х	IF = 60mA	-	0.31	-	-
CIE Coordinates	Y	IF = 60mA	-	0.32	-	-
Forward Voltage (per chip)	VF	IF = 60mA	1	3.1	3.6	V
Luminous Intensity (per chip)	lv	IF = 60mA	4000	5500		mcd
Viewing Angle at 50% Iv	201/2	IF = 60mA	ı	120		Deg

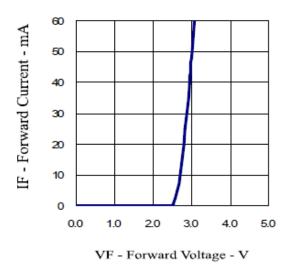
^{*}Tolerance of viewing angle: -10 / +5 deg.



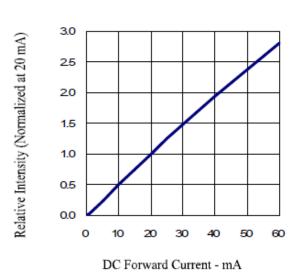


OPTICAL CHARACTERISTIC CURVES

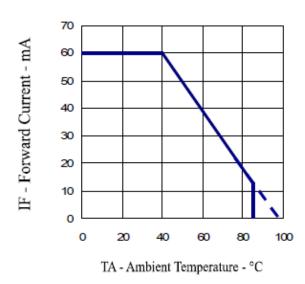
Forward Current vs. Forward Voltage



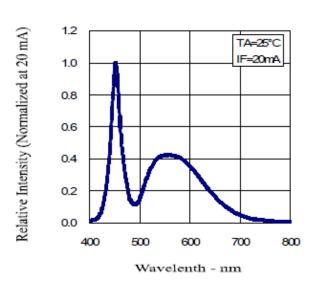
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



Relative Intensity vs. Wavelength

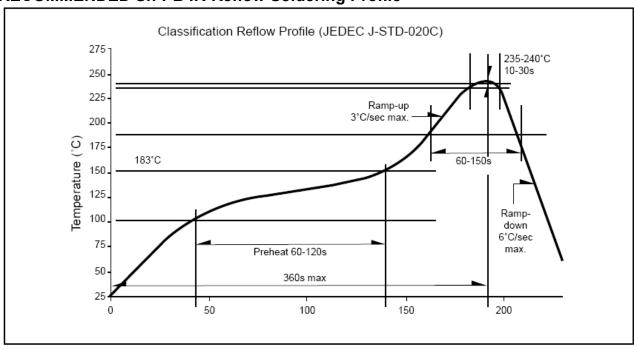




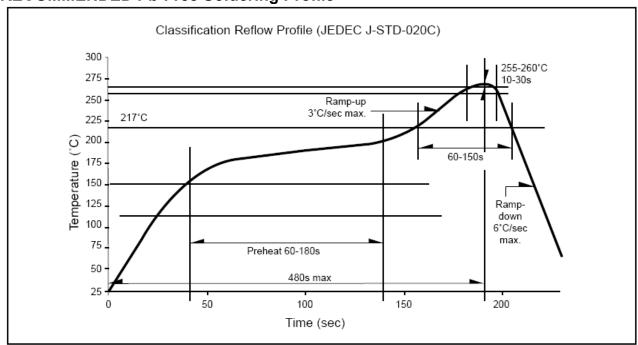


SOLDERING CONDITIONS

RECOMMENDED Sn-PB IR-Reflow Soldering Profile



RECOMMENDED Pb-Free Soldering Profile







PACKAGING SPECIFICATION

Tape dimension

